## June 2004

FDD6688/FDU6688



## FDD6688/FDU6688

## 30V N-Channel PowerTrench<sup>o</sup> MOSFET

## **General Description**

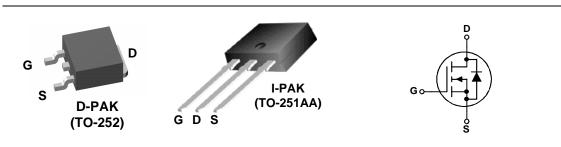
This N-Channel MOSFET has been designed specifically to improve the overall efficiency of DC/DC converters using either synchronous or conventional switching PWM controllers. It has been optimized for low gate charge, low RDS(ON) and fast switching speed.

## Applications

- DC/DC converter
- Motor Drives

## Features

- 84 A, 30 V.  $R_{DS(ON)} = 5 \text{ m}\Omega @ V_{GS} = 10 \text{ V}$  $R_{DS(ON)} = 6 \text{ m}\Omega @ V_{GS} = 4.5 \text{ V}$
- Low gate charge
- Fast switching
- High performance trench technology for extremely low  $R_{\text{DS}(\text{ON})}$



## Absolute Maximum Ratings T<sub>A=25°C</sub> unless otherwise noted

Symbo I	Parameter		Ratings	Units
V <sub>DSS</sub>	Drain-Source Voltage		30	V
V <sub>GSS</sub>	Gate-Source Voltage		±20	
I <sub>D</sub>	Drain Current – Continuous	(Note 3)	84	A
	– Pulsed	(Note 1a)	100	
PD	Power Dissipation for Single Operation	(Note 1)	83	W
		(Note 1a)	3.8	
		(Note 1b)	1.6	
T <sub>J</sub> , T <sub>STG</sub>	Operating and Storage Junction Temperature Range		-55 to +175	°C

## **Thermal Characteristics**

$R_{\theta JC}$	Thermal Resistance, Junction-to-Case	(Note 1)	1.8	°C/W
$R_{\theta JA}$	Thermal Resistance, Junction-to-Ambient	(Note 1a)	40	
		(Note 1b)	96	

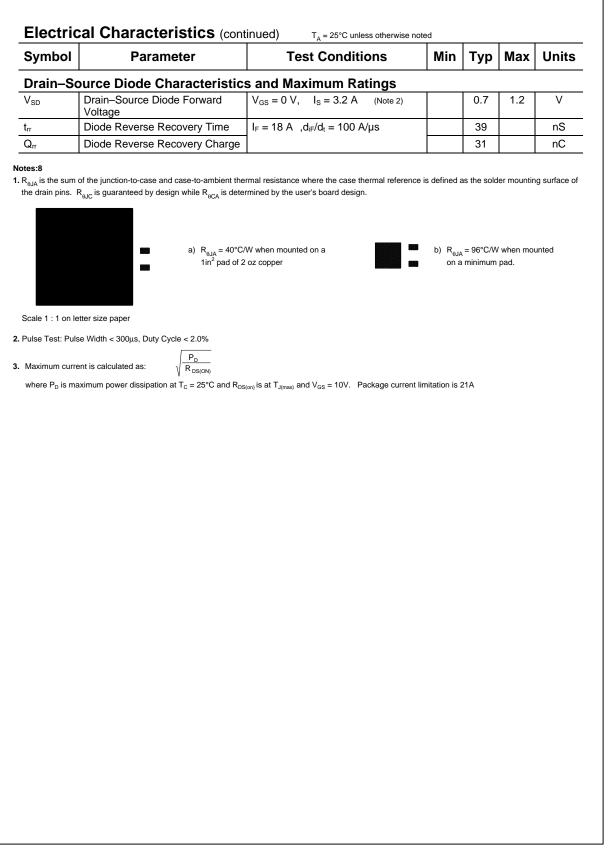
## **Package Marking and Ordering Information**

Device Marking	Device	Package	Reel Size	Tape width	Quantity
FDD6688	FDD6688	D-PAK (TO-252)	13"	12mm	2500 units
FDU6688	FDU6688	I-PAK (TO-251)	Tube	N/A	75

©2004 Fairchild Semiconductor Corporation

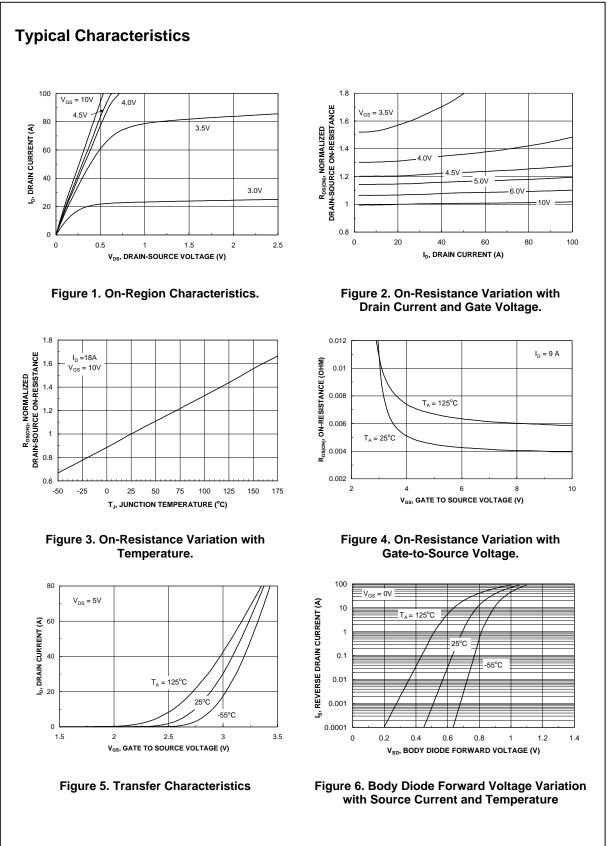
Symbol	Parameter	Test Conditions	Min	Тур	Max	Units
Drain-So	burce Avalanche Ratings (No	ote 2)	•			
W <sub>DSS</sub>	Drain-Source Avalanche Energy	Single Pulse, $V_{DD} = 15 \text{ V}$ , $I_D = 21 \text{ A}$			370	mJ
I <sub>AR</sub>	Drain-Source Avalanche Current				21	А
Off Char	acteristics					
BV <sub>DSS</sub>	Drain–Source Breakdown Voltage	$V_{GS} = 0 \text{ V}, \qquad I_D = 250 \mu\text{A}$	30			V
<u>ΔBVdss</u> ΔTj	Breakdown Voltage Temperature Coefficient	$I_D = 250 \ \mu\text{A}$ , Referenced to $25^{\circ}\text{C}$		24		mV/∘C
I <sub>DSS</sub>	Zero Gate Voltage Drain Current	$V_{\text{DS}} = 24 \text{ V}, \qquad V_{\text{GS}} = 0 \text{ V}$			1	μA
I <sub>GSS</sub>	Gate-Body Leakage	$V_{GS} = \pm 20 \text{ V}, \qquad V_{DS} = 0 \text{ V}$			±100	nA
On Char	acteristics (Note 2)					
V <sub>GS(th)</sub>	Gate Threshold Voltage	$V_{DS} = V_{GS}$ , $I_D = 250 \ \mu A$	1	1.8	3	V
$\frac{\Delta V_{GS(th)}}{\Delta T_J}$	Gate Threshold Voltage Temperature Coefficient	$I_D = 250 \ \mu\text{A}$ , Referenced to $25^{\circ}\text{C}$		-5		mV/°C
R <sub>DS(on)</sub>	Static Drain–Source On–Resistance			4 5 6	5 6 10	mΩ
I <sub>D(on)</sub>	On–State Drain Current	$V_{GS} = 10 \text{ V}, \qquad V_{DS} = 5 \text{ V}$	50	_		А
<b>g</b> <sub>FS</sub>	Forward Transconductance	$V_{DS} = 5 V$ , $I_D = 18 A$		88		S
Dvnamio	Characteristics					
C <sub>iss</sub>	Input Capacitance	$V_{DS} = 15 V$ , $V_{GS} = 0 V$ ,		3845		pF
Coss	Output Capacitance	f = 1.0 MHz		930		pF
Crss	Reverse Transfer Capacitance			368		pF
R <sub>G</sub>	Gate Resistance	V <sub>GS</sub> = 15 mV, f = 1.0 MHz		1.2		Ω
Switchir	g Characteristics (Note 2)			1		
t <sub>d(on)</sub>	Turn-On Delay Time	$V_{DD} = 15 \text{ V}, \qquad I_D = 1 \text{ A},$		15	27	ns
tr	Turn–On Rise Time	$V_{GS} = 10 \text{ V},  R_{GEN} = 6 \Omega$		13	23	ns
t <sub>d(off)</sub>	Turn–Off Delay Time			62	99	ns
t <sub>f</sub>	Turn–Off Fall Time	1		36	58	ns
Q <sub>g</sub>	Total Gate Charge	$V_{DS} = 15V,$ $I_D = 18 A,$		37	56	nC
Q <sub>gs</sub>	Gate-Source Charge	$V_{GS} = 5 V$		10		nC
Q <sub>gd</sub>	Gate-Drain Charge			14		nC

# FDD6688/FDU6688



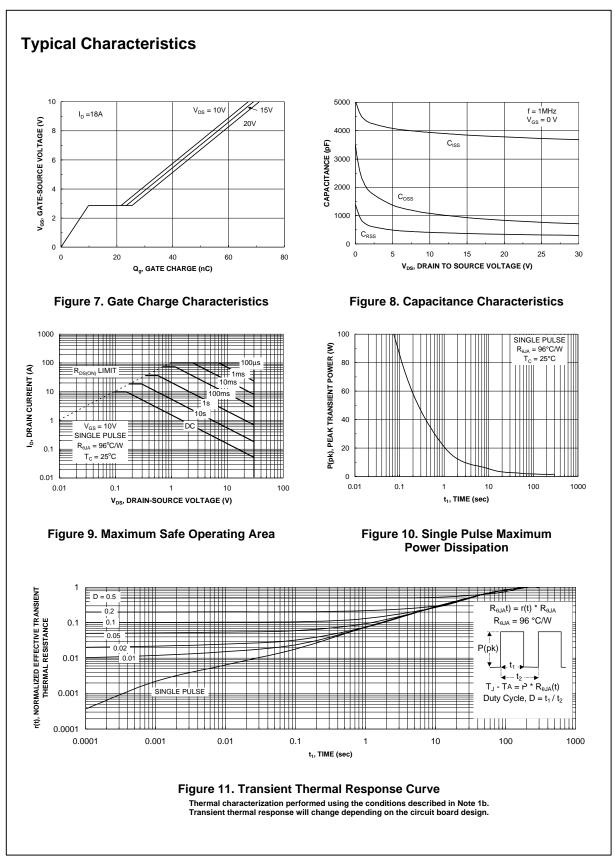
FDD6688/FDU6688 Rev F(W)

# FDD6688/FDU6688



FDD6688/FDU6688

FDD6688/FDU6688 Rev F(W)



# FDD6688/FDU6688

FDD6688/FDU6688 Rev F(W)

## TRADEMARKS

The following are registered and unregistered trademarks Fairchild Semiconductor owns or is authorized to use and is not intended to be an exhaustive list of all such trademarks.

	FAST®		Power247™	SuperFET™
ActiveArray™	FASTr™	LittleFET™	PowerSaver™	SuperSOT™-3
Bottomless™	FPS™	MICROCOUPLER™	PowerTrench <sup>®</sup>	SuperSOT™-6
CoolFET™	FRFET™	MicroFET™	QFET <sup>®</sup>	SuperSOT™-8
CROSSVOLT™	GlobalOptoisolator™	MicroPak™	QS™	SyncFET™
DOME™	GTO™	MICROWIRE™	QT Optoelectronics <sup>™</sup>	TinyLogic <sup>®</sup>
EcoSPARK™	HiSeC™	MSX™	Quiet Series <sup>™</sup>	TINYOPTO™
E <sup>2</sup> CMOS™	l²C™	MSXPro™	RapidConfigure™	TruTranslation™
EnSigna™	<i>i-Lo</i> ™	OCX™	RapidConnect™	UHC™
FACT™	ImpliedDisconnect <sup>™</sup>	OCXPro™	µSerDes™	UltraFET <sup>®</sup>
FACT Quiet Series <sup>™</sup>		<b>OPTOLOGIC</b> <sup>®</sup>	SILENT SWITCHER®	VCX™
Across the board. Around the world.™		OPTOPLANAR™	SMART START™	
The Power Franchise <sup>®</sup>		PACMAN™	SPM™	
Programmable Active Droop <sup>™</sup>		POP™	Stealth™	
i iogiainnabio/				

## DISCLAIMER

FAIRCHILD SEMICONDUCTOR RESERVES THE RIGHT TO MAKE CHANGES WITHOUT FURTHER NOTICE TO ANY PRODUCTS HEREIN TO IMPROVE RELIABILITY, FUNCTION OR DESIGN. FAIRCHILD DOES NOT ASSUME ANY LIABILITY ARISING OUT OF THE APPLICATION OR USE OF ANY PRODUCT OR CIRCUIT DESCRIBED HEREIN; NEITHER DOES IT CONVEY ANY LICENSE UNDER ITS PATENT RIGHTS, NOR THE RIGHTS OF OTHERS.

## LIFE SUPPORT POLICY

FAIRCHILD'S PRODUCTS ARE NOT AUTHORIZED FOR USE AS CRITICAL COMPONENTS IN LIFE SUPPORT DEVICES OR SYSTEMS WITHOUT THE EXPRESS WRITTEN APPROVAL OF FAIRCHILD SEMICONDUCTOR CORPORATION. As used herein:

1. Life support devices or systems are devices or systems which, (a) are intended for surgical implant into the body, or (b) support or sustain life, or (c) whose failure to perform when properly used in accordance with instructions for use provided in the labeling, can be reasonably expected to result in significant injury to the user. 2. A critical component is any component of a life support device or system whose failure to perform can be reasonably expected to cause the failure of the life support device or system, or to affect its safety or effectiveness.

## **PRODUCT STATUS DEFINITIONS**

### **Definition of Terms**

Datasheet Identification	Product Status	Definition
Advance Information	Formative or In Design	This datasheet contains the design specifications for product development. Specifications may change in any manner without notice.
Preliminary	First Production	This datasheet contains preliminary data, and supplementary data will be published at a later date. Fairchild Semiconductor reserves the right to make changes at any time without notice in order to improve design.
No Identification Needed	Full Production	This datasheet contains final specifications. Fairchild Semiconductor reserves the right to make changes at any time without notice in order to improve design.
Obsolete	Not In Production	This datasheet contains specifications on a product that has been discontinued by Fairchild semiconductor. The datasheet is printed for reference information only.
		Rev. I11